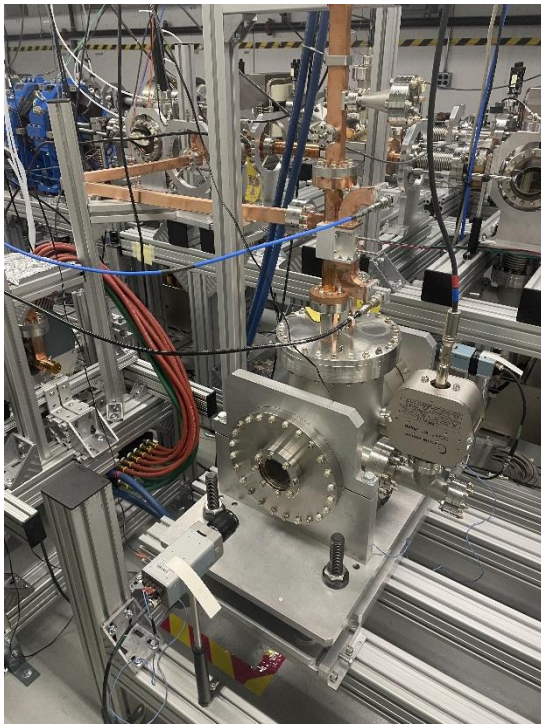
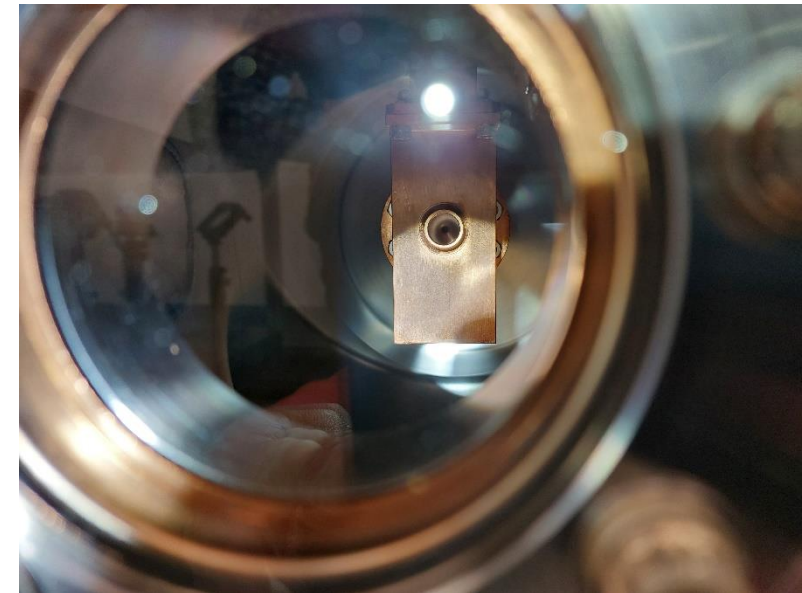


# High Power Test Results of X-Band Dielectric Disk Accelerating Structures



Ben Freemire  
for Euclid Beamlabs &  
Argonne Wakefield Accelerator

International Workshop on Breakdown Science and  
High Gradient Technology  
19 May 2022



# Motivation

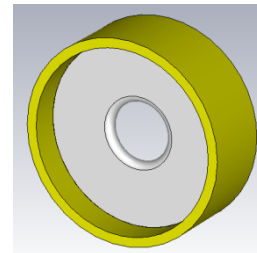
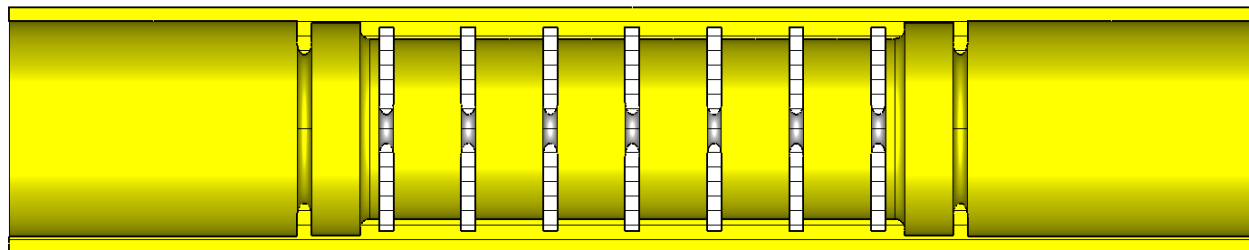
- Develop enabling technologies for TeV-scale linear colliders
- Support demonstration of 500 MeV electron beam energy gain using Two Beam Acceleration approach at Argonne Wakefield Accelerator
- Improve RF-to-beam efficiency
  - High shunt impedance and  $r/Q$
  - High group velocity
- Short pulse – high gradient acceleration
  - Capitalizes on RF breakdown rate  $\propto$  RF pulse length

# Dielectric Disk Accelerators

- Dielectric disk-loaded waveguides introduced in the 1940's-50's
- Modern ceramics with high dielectric constant and low loss provide opportunity to realize high shunt impedance structures
- Higher: group velocity, shunt impedance,  $Q$
- Tuning easier than for DLAs
- Drawback: surface electric field much higher than DLAs, fabrication difficult

26 GHz Parameter	DDA	DLA	Copper-Disk*
Aperture	3 mm	3 mm	3 mm
Outer Diameter	9.23 mm	4.99 mm	9.27 mm
Thickness	0.5 mm	1 mm (wall)	0.5 mm
Dielectric constant	50	10	N/A
Loss tangent	5e-4	1e-4	N/A
Group velocity	0.16c	0.11c	0.017c
Shunt Impedance	208 M $\Omega$ /m	50 M $\Omega$ /m	139 M $\Omega$ /m
$Q$	6400	2300	4300
Accel. gradient	363 MV/m	363 MV/m	N/A
Surface gradient	660 MV/m	363 MV/m	N/A

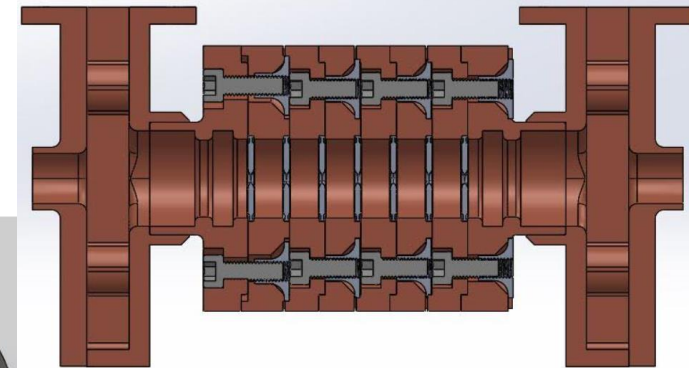
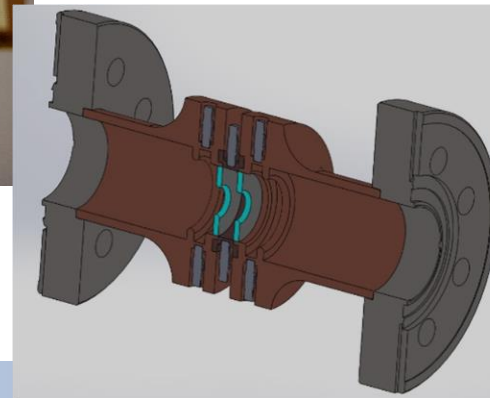
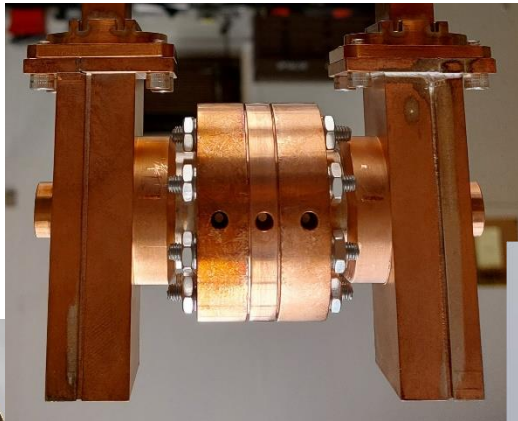
\*Constant impedance  $2\pi/3$  structure, not suitable for short RF pulse acceleration due to low group velocity



# Euclid-AWA DDA Testing History

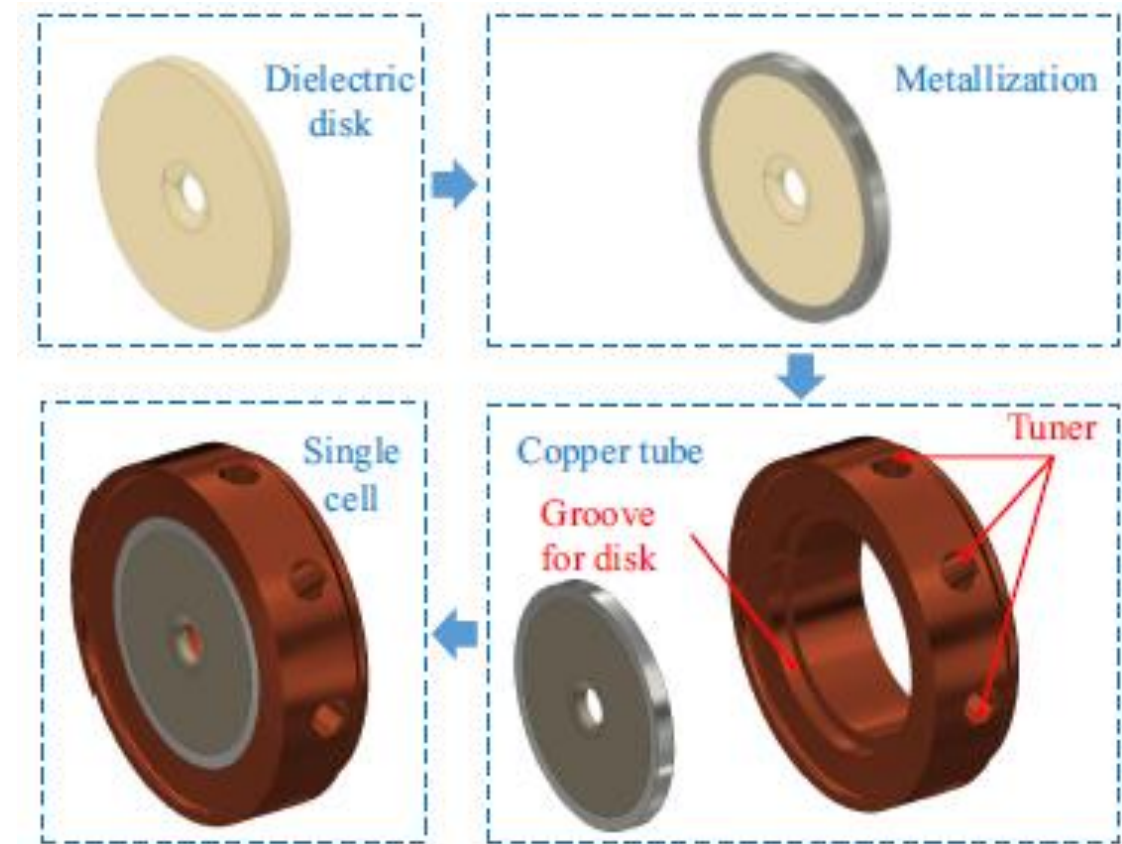
- Prototype I – Brazed: Dec. 2019-Jan. 2020
- Prototype II – Brazed: Failed during brazing
- Prototype III – Clamped: Dec. 2021-Jan. 2022
- Prototype IV – Brazed: upcoming 2022
- Multicell – Clamped: upcoming 2022

S. Weatherly poster Thurs.



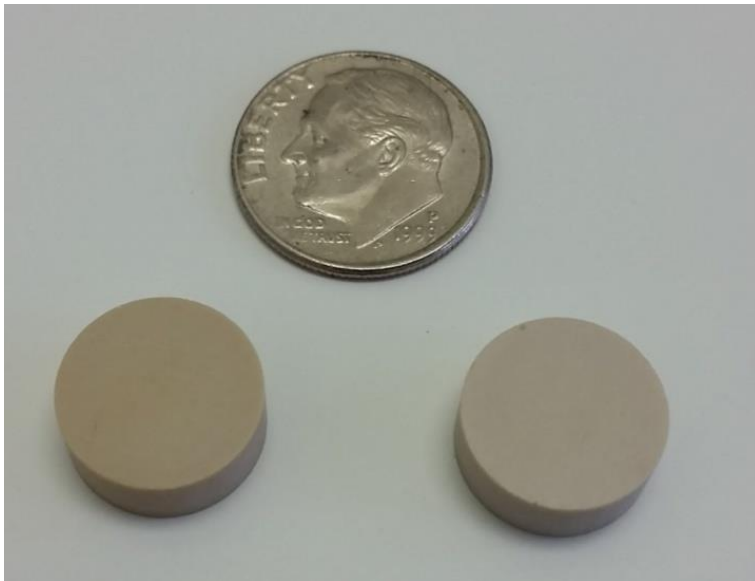
# Fabrication Challenges

- Most significant challenge for program
- Precision of dielectric properties
- Machining feasibility/tolerance
- *Brazing vs. Clamping*



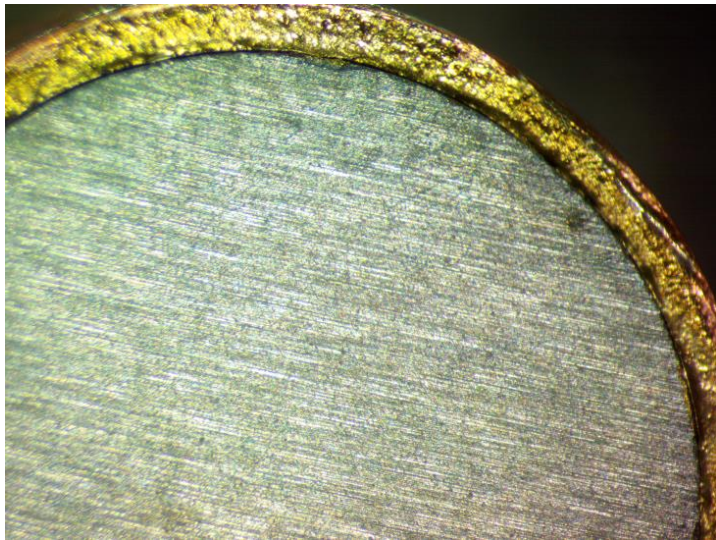
# Dielectric Material Characterization

- Prototype I & II:
- BaTiO<sub>x</sub> ceramic (D-50) from Skyworks (Trans-Tech)
- 10 coupons measured (4 GHz):
  - $\epsilon_r = 50.14 \pm 0.35$
  - $\tan \delta = 8.00e-5 \pm 0.32e-5$
- Prototype III:
- Ca<sub>v</sub>Ti<sub>w</sub>La<sub>x</sub>Al<sub>y</sub>O<sub>z</sub> ceramic (D-47) from Keramika
- 3 coupons measured (3.8-7.4 GHz), extrapolated to 11.7 GHz
  - $\epsilon_r = 47.7$
  - $\tan \delta = 3.44e-4$



# Investigation of Brazing Method

- High temperature InCuSil-ABA @835°C in vacuum furnace
- Hermetic seal successful; ceramic became lossy
- Post-braze bake in air reduced RF loss
- *Oxygen escapes in vacuum at high temperature but can be reintroduced*



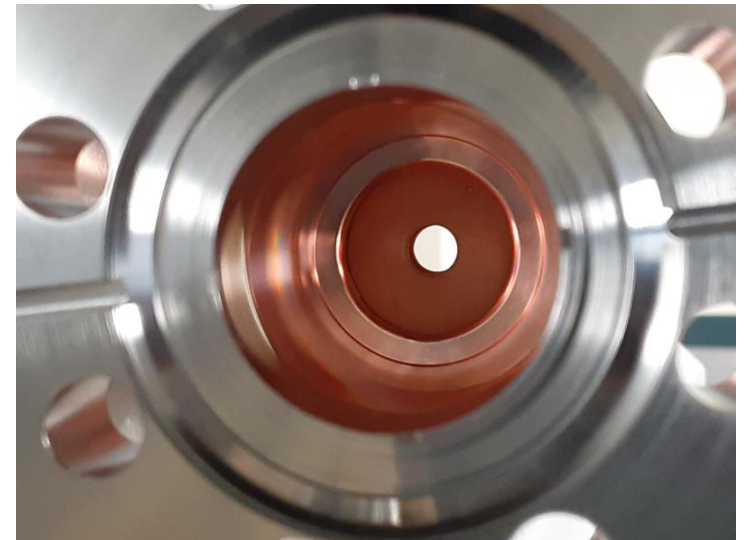
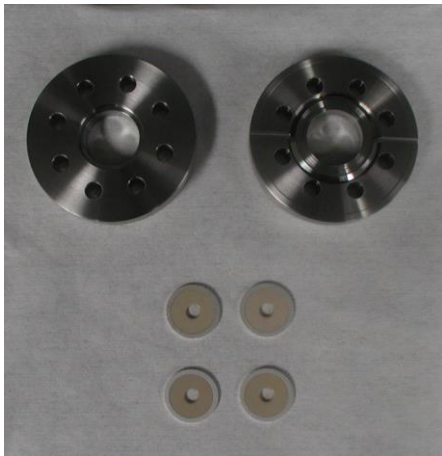
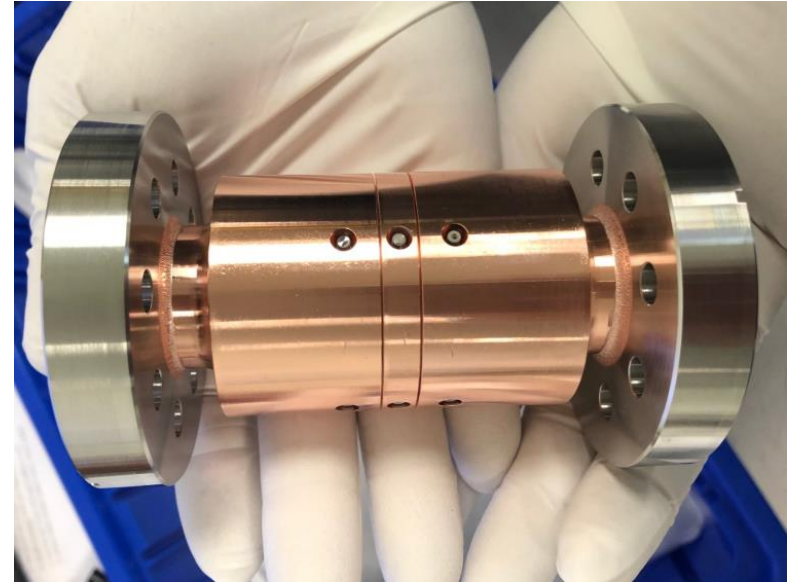
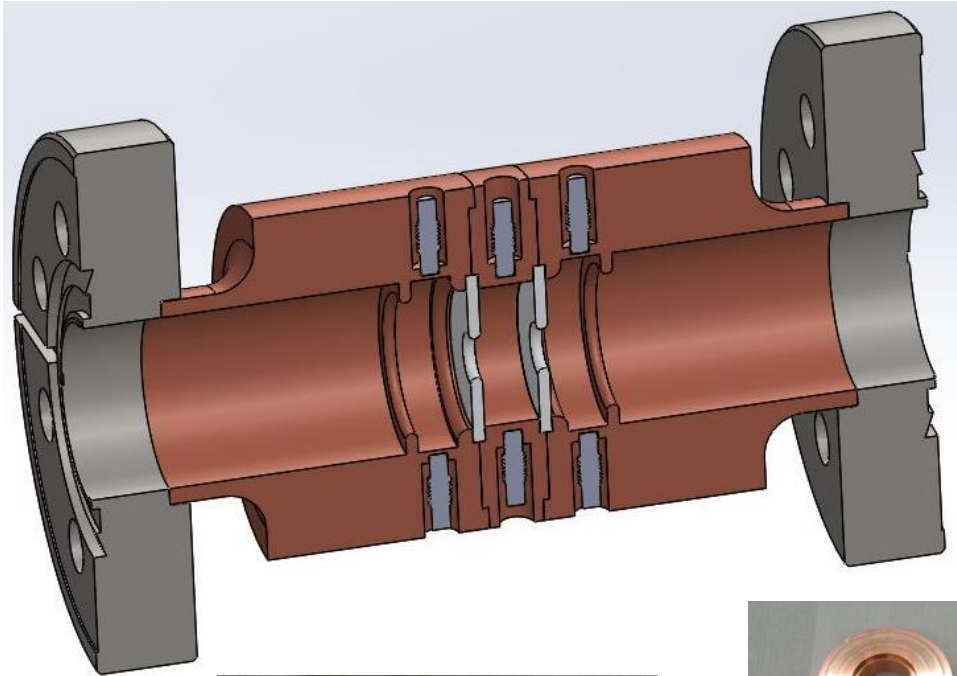
	Temp.	Time	$\epsilon_r$	$\tan \delta$
Original	-	-	50.2	8.15e-5
Post-Braze	835	N/A	49.7	1.43e-2
Post-Bake 1	800	60 min.	49.3	7.17e-4
Post-Bake 2	800	60 min.	49.3	1.03e-4

# Choice of Brazing Method

- Low temperature solder (Au-Sn, 350°C) with silver-metallized disks chosen for Prototype I
  - Metallization @ 850°C in air, preserved dielectric properties
- High temperature ABA (InCuSil, 850°C) with nude disks chosen for Prototype II
  - Leaked after first braze cycle
  - Second braze cycle improved leak
  - Third braze cycle cracked ceramic disks

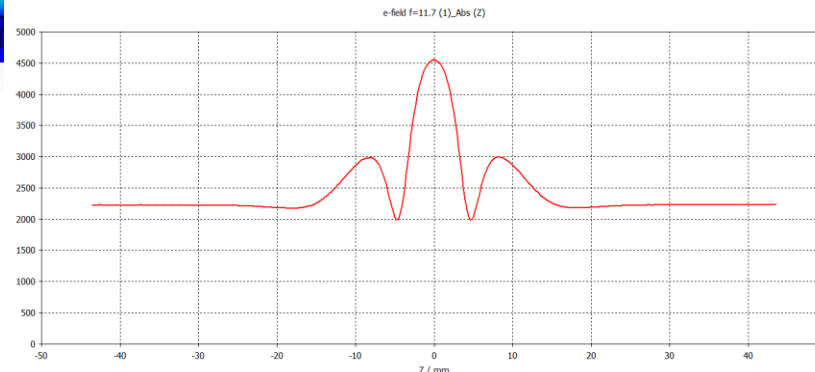
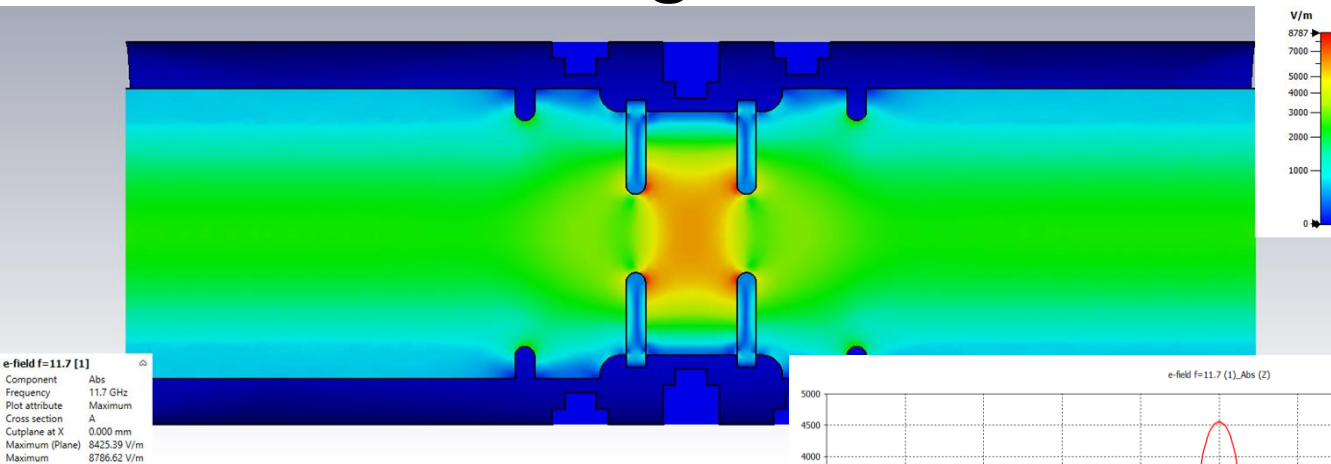
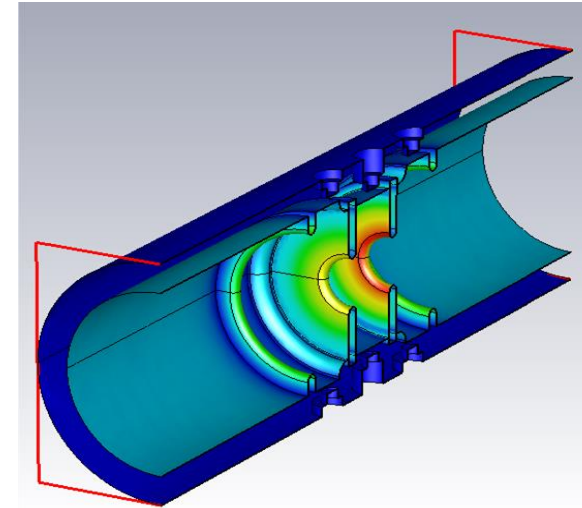


# Brazed Prototype Fabrication



# Brazed Prototype RF Design

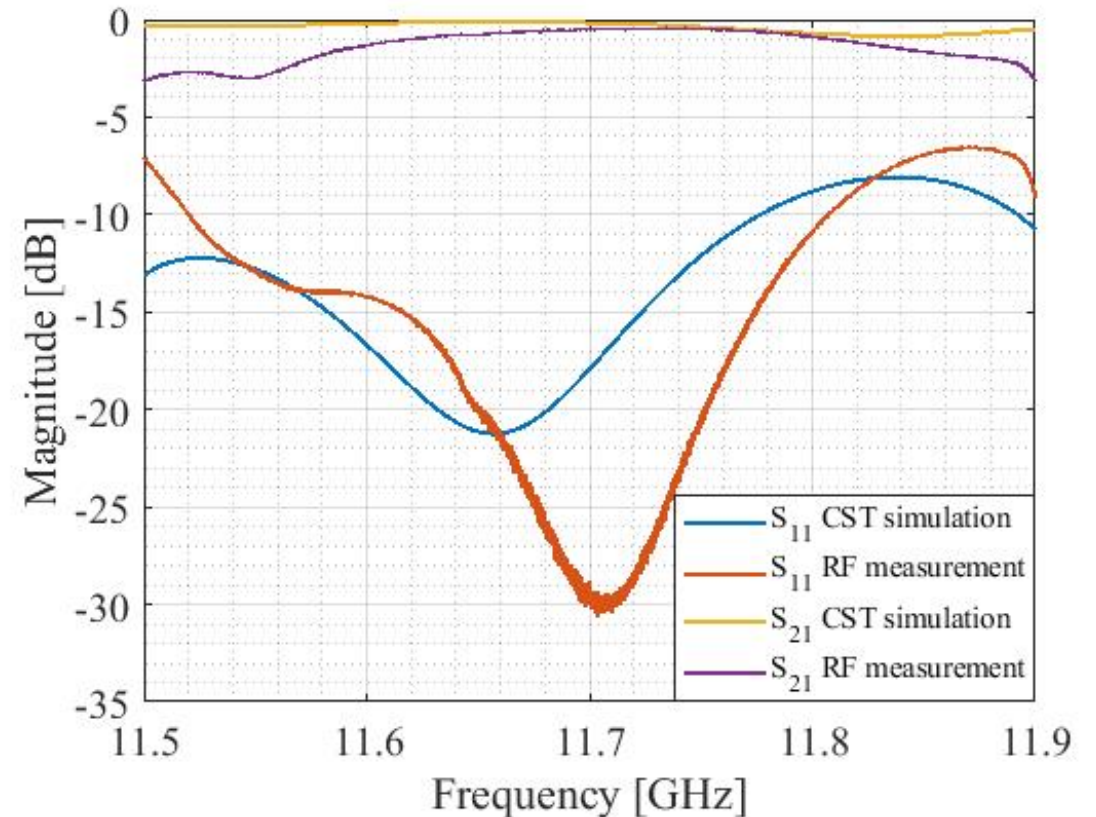
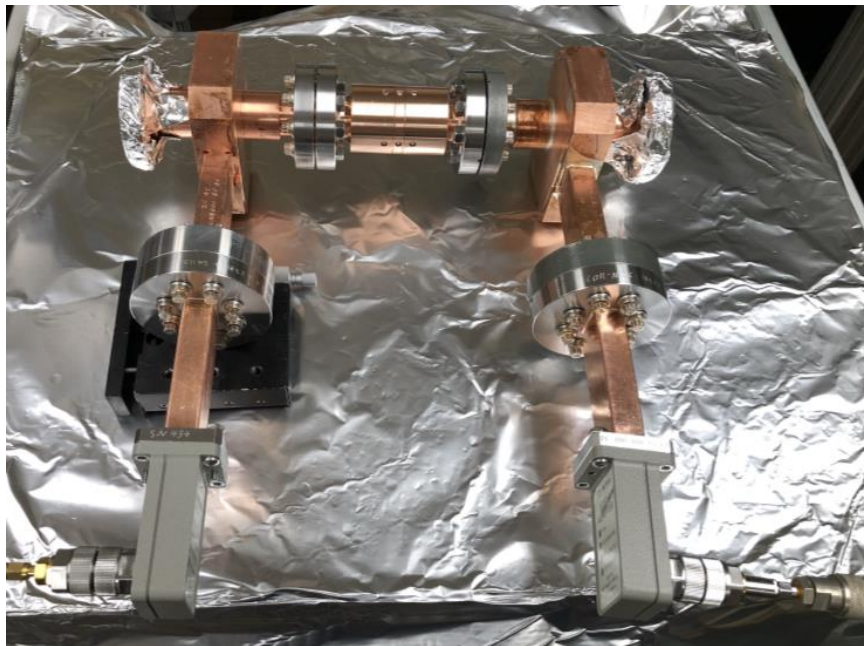
- 1 Dielectric cell (2 disks) + 2 matching cells
- $f = 11.7$  GHz, three sets of 4 tuners each allow  $\pm 3$  MHz range



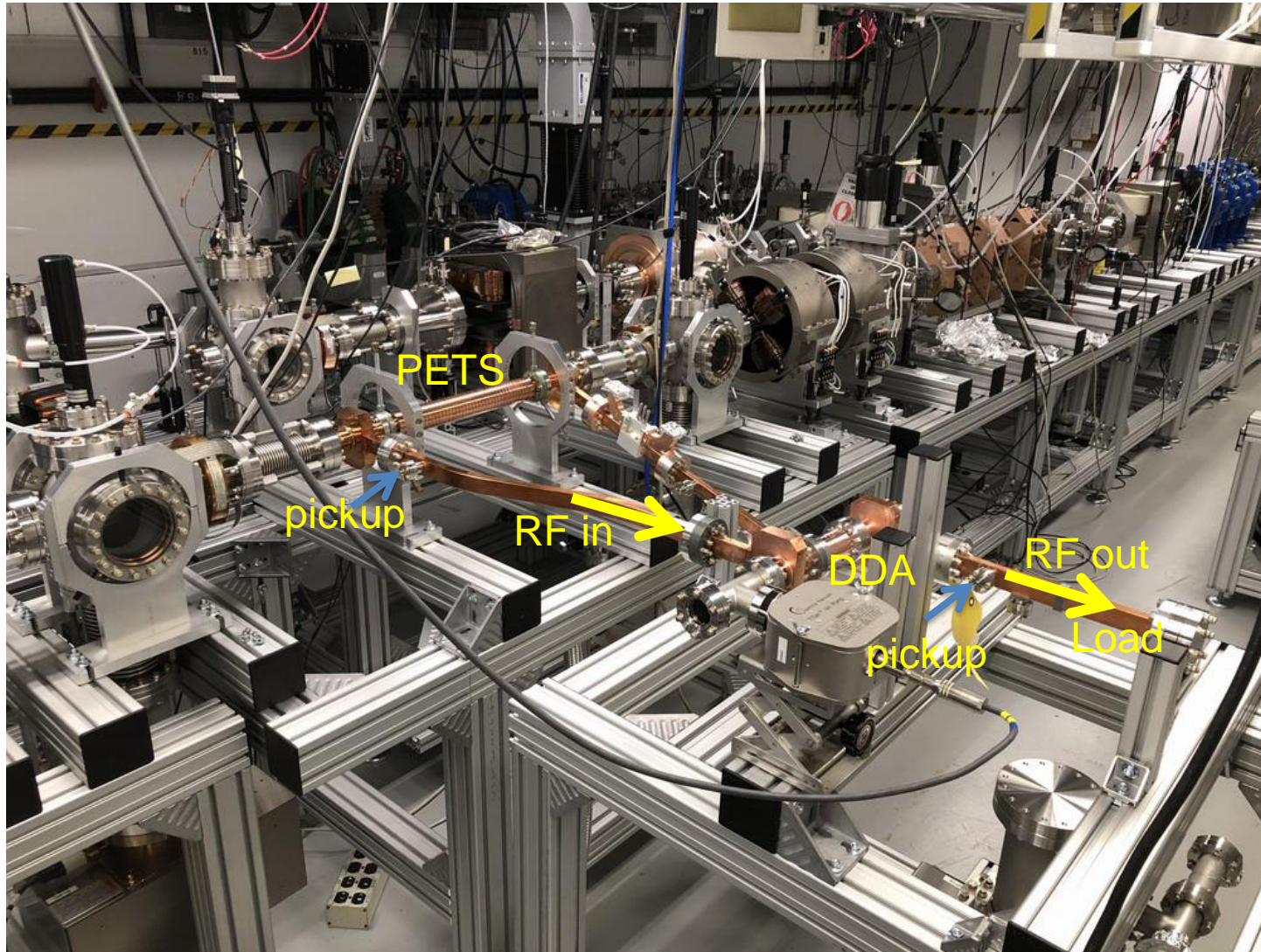
Dielectric constant	50.1
Loss tangent	8e-5
Q	10,300
Shunt impedance	176 M $\Omega$ /m
Group velocity	0.345c
Phase advance	$2\pi/3$
$E_{acc} (P_{in})$	100 MV/m (280 MW)
$E_{max} / E_{acc}$	1.84

# Brazed Prototype Bench Test

- Measured  $S_{21} = -0.50$  dB &  $S_{11}$  10 dB BW = 290 MHz
- Differences attributable to discrepancies in machined dimensions/dielectric constant
  - Couplers included in simulation
- No tuning required



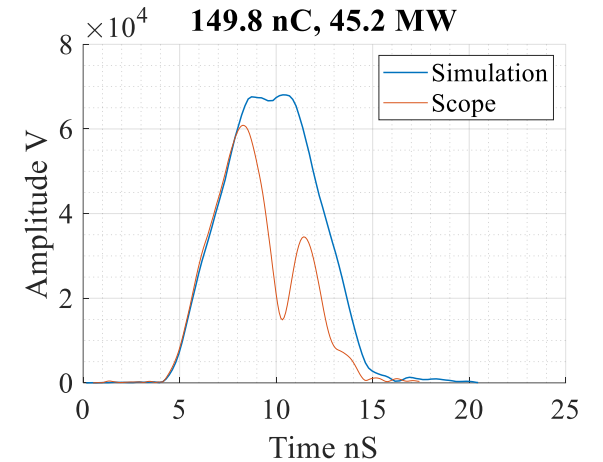
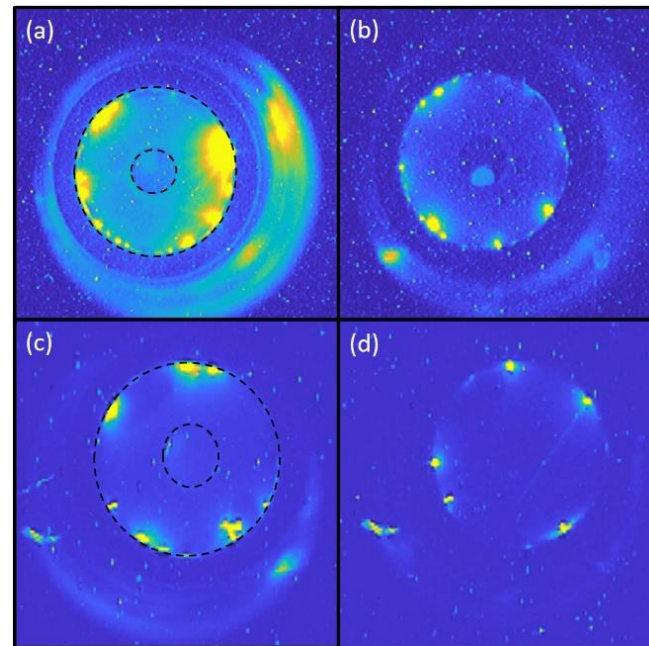
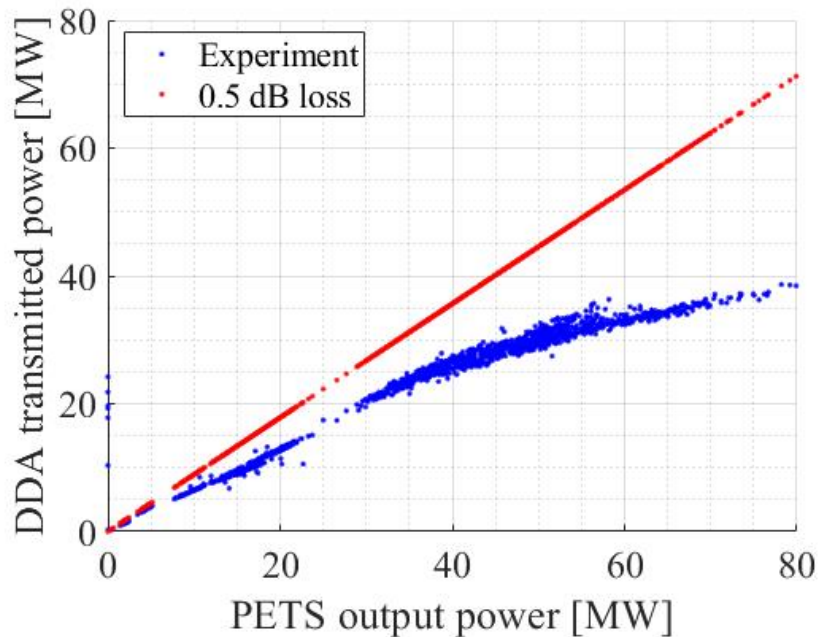
# High Power Test Setup



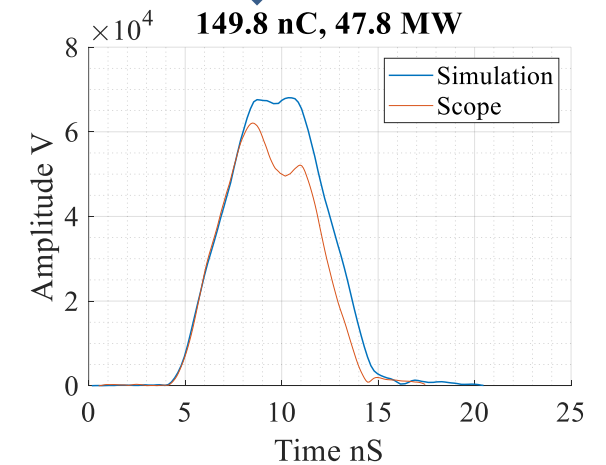
- Power provided by Power Extraction and Transport Structure (PETS)
- ICTs measure beam current for power generation
- Directional couplers at DDA input & output
- Instrumentation to look for multipacting/breakdown
  - Ion pump & vacuum gauge
  - Cameras on both ends of DDA

# Brazed Prototype High Power Test Results

- Significant multipactor/breakdown activity observed
- Light emission from circumference of both ceramic disks
  - No light visible from irises
- Conditioning improved power transmission & light emission somewhat; never eliminated
- Run aborted at 80 MW input power

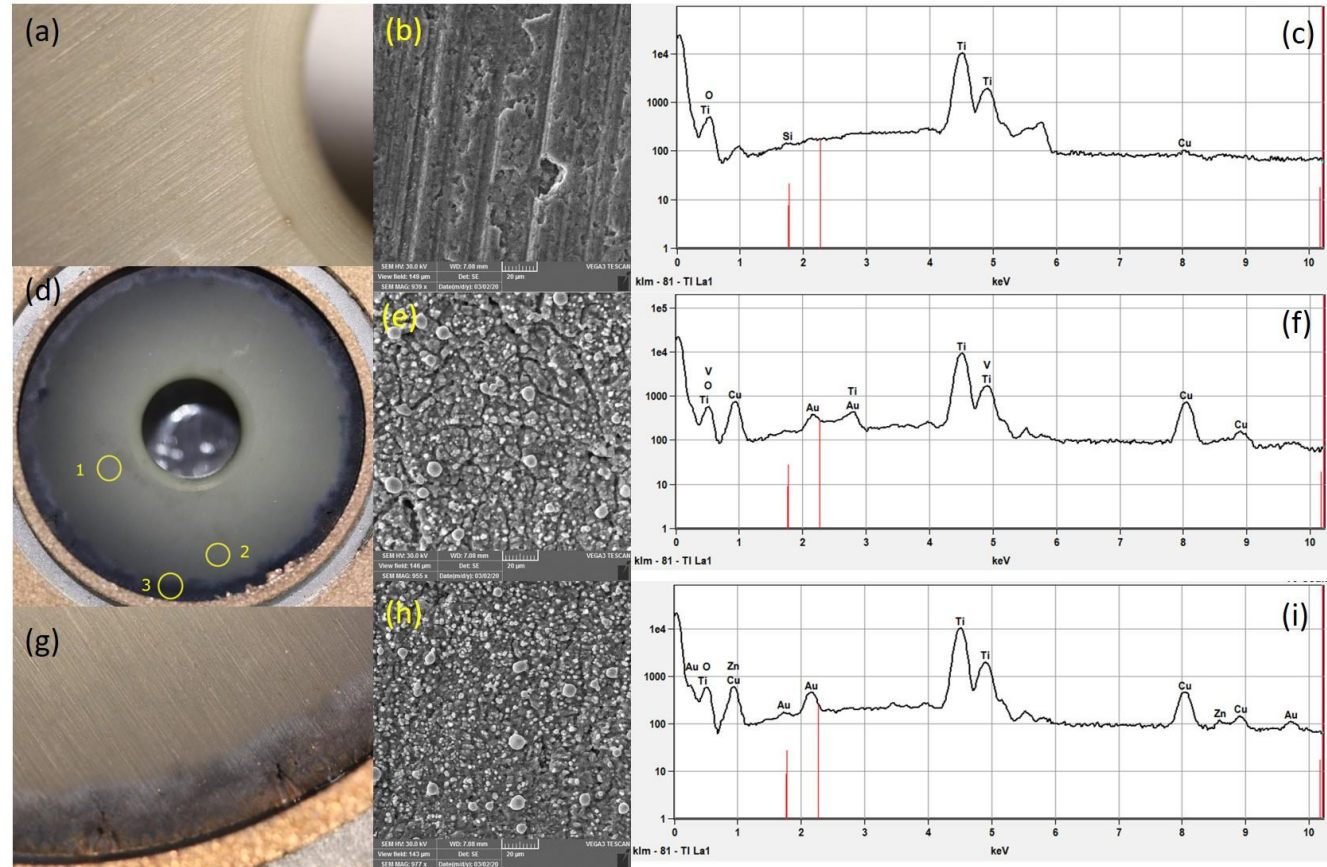
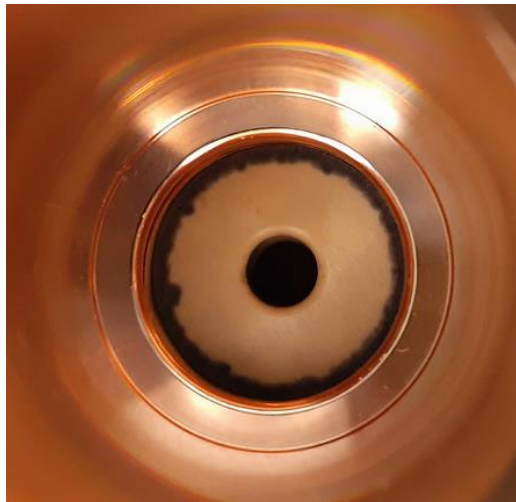


Conditioning



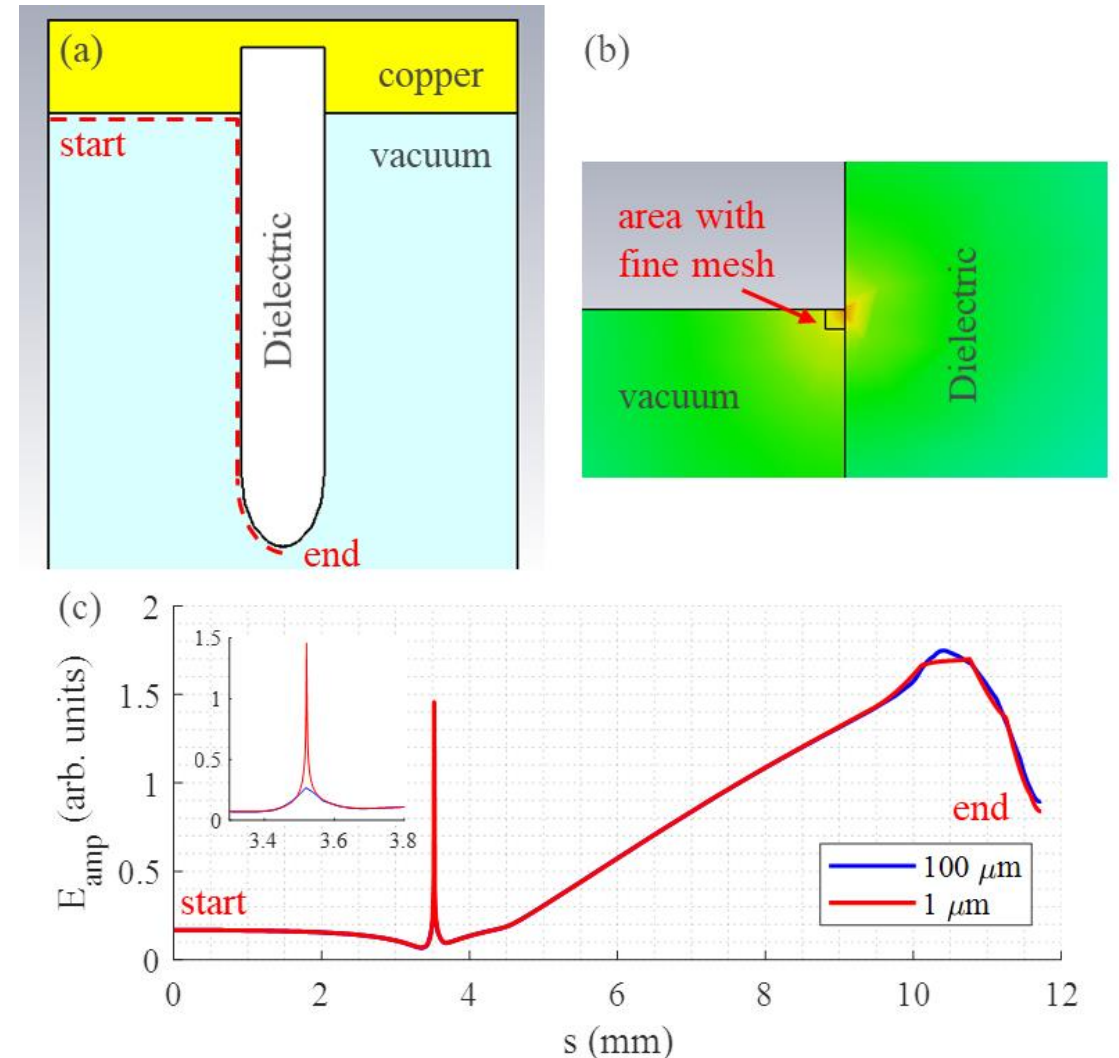
# Brazed Prototype Autopsy

- Damage around ceramic circumference
- SEM & EDX results reveal pitting and presence of gold (braze alloy) and copper near outer radius of disks
- Iris & surrounding area free from damage or contamination
- Breakdown/ multipactor confined to triple junction region



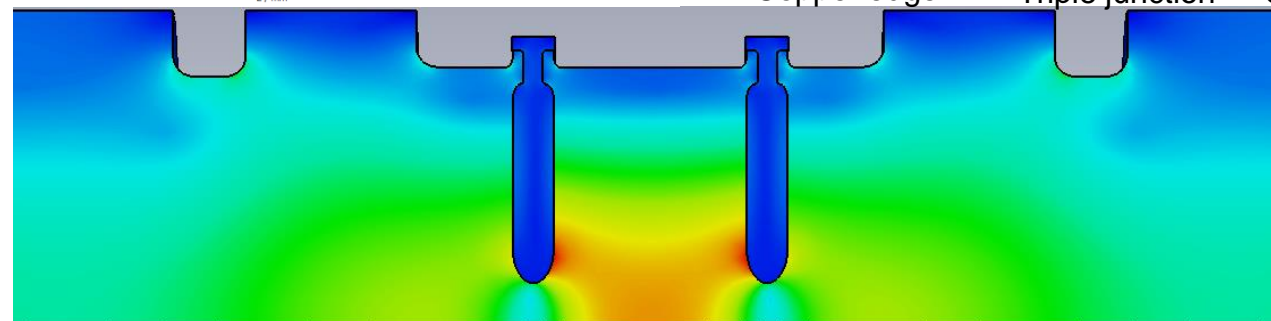
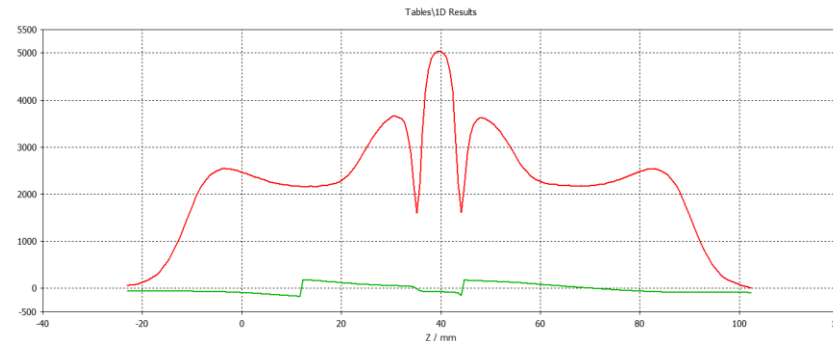
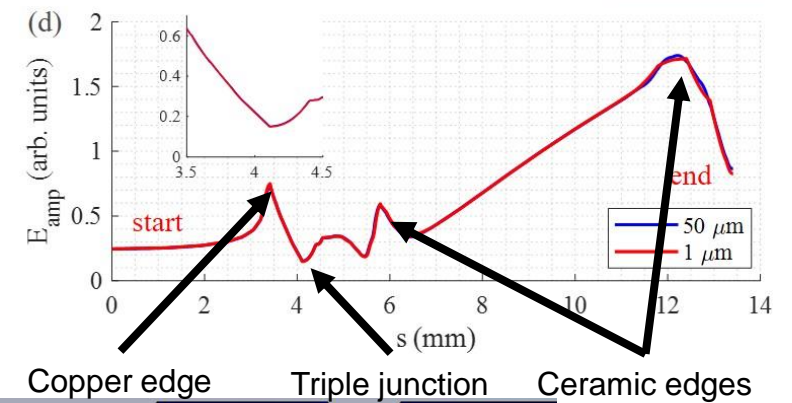
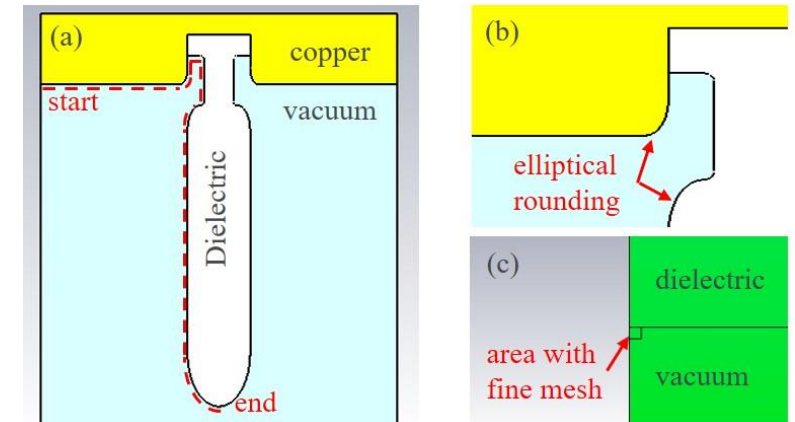
# Brazed Prototype Conclusions

- Finer mesh revealed field enhancement at triple junction
- No evidence of problems stemming from iris or ceramic material
- Engineering challenge to overcome, not fundamental



# Clamped Prototype RF Design

- Triple junction redesigned to minimize E-field
- Elliptic rounding added to copper and ceramic

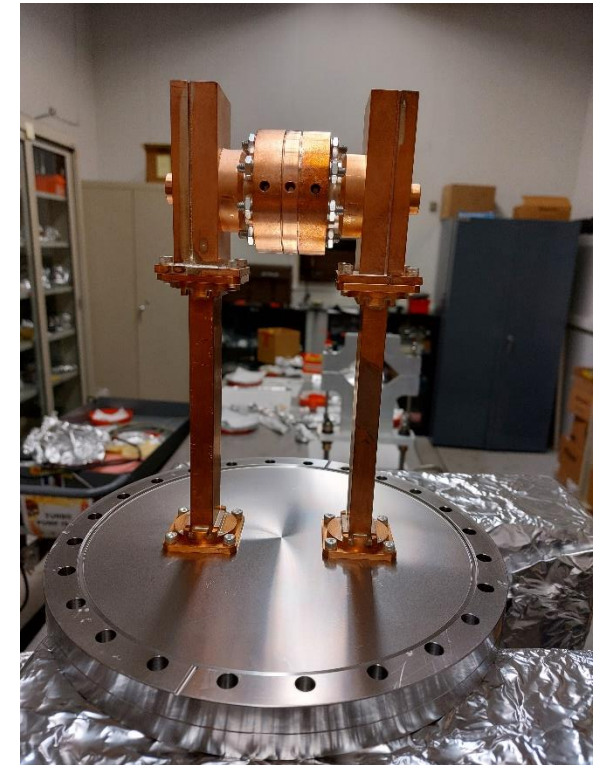
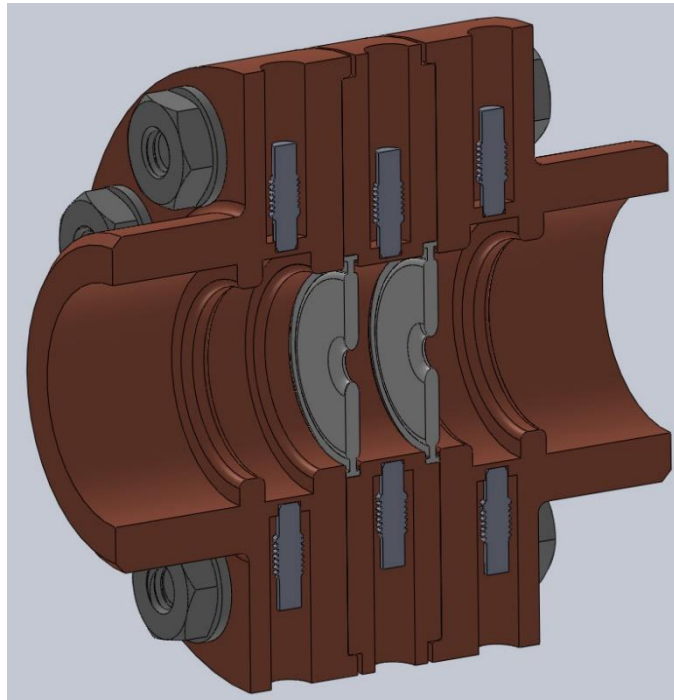
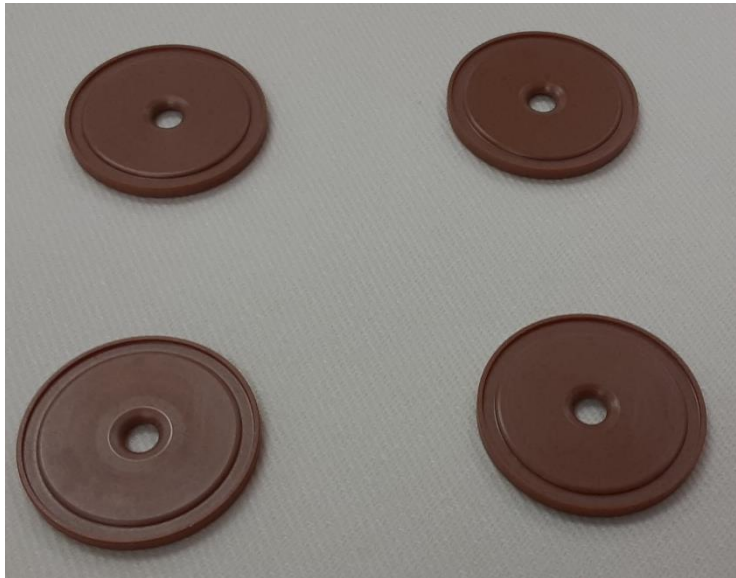


Dielectric constant	47.7
Loss tangent	3.4e-5
Q	8,500
Shunt impedance	174 M $\Omega$ /m
Group velocity	0.27c
Phase advance	$2\pi/3$
$E_{acc}$ (308 MW)	100 MV/m
$E_{max} / E_{acc}$	1.44



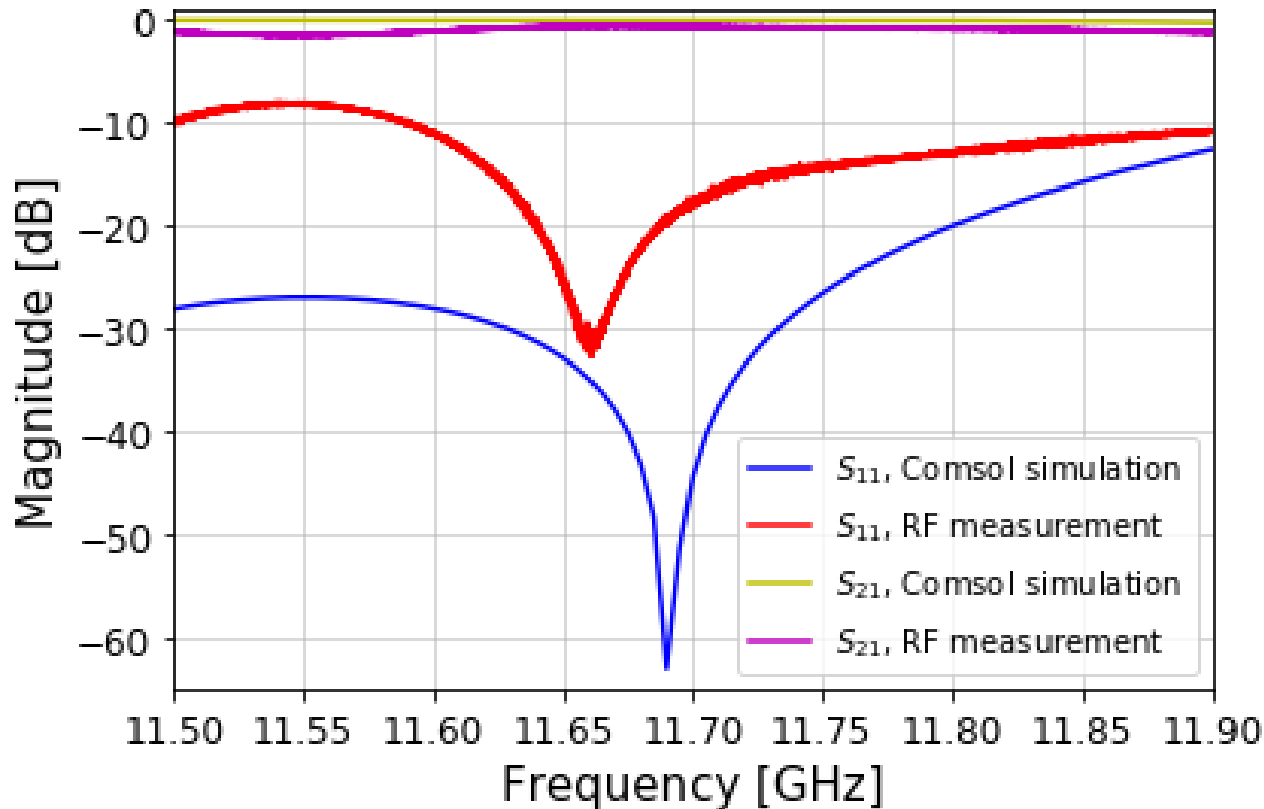
# Clamped Prototype Fabrication

- Potential problem associated with braze alloy avoided
- No vacuum seal (tested in vacuum chamber)
- Outer edge of ceramic disks bite into annealed copper parts
- Ceramic design more difficult to machine



# Clamped Prototype Bench Test

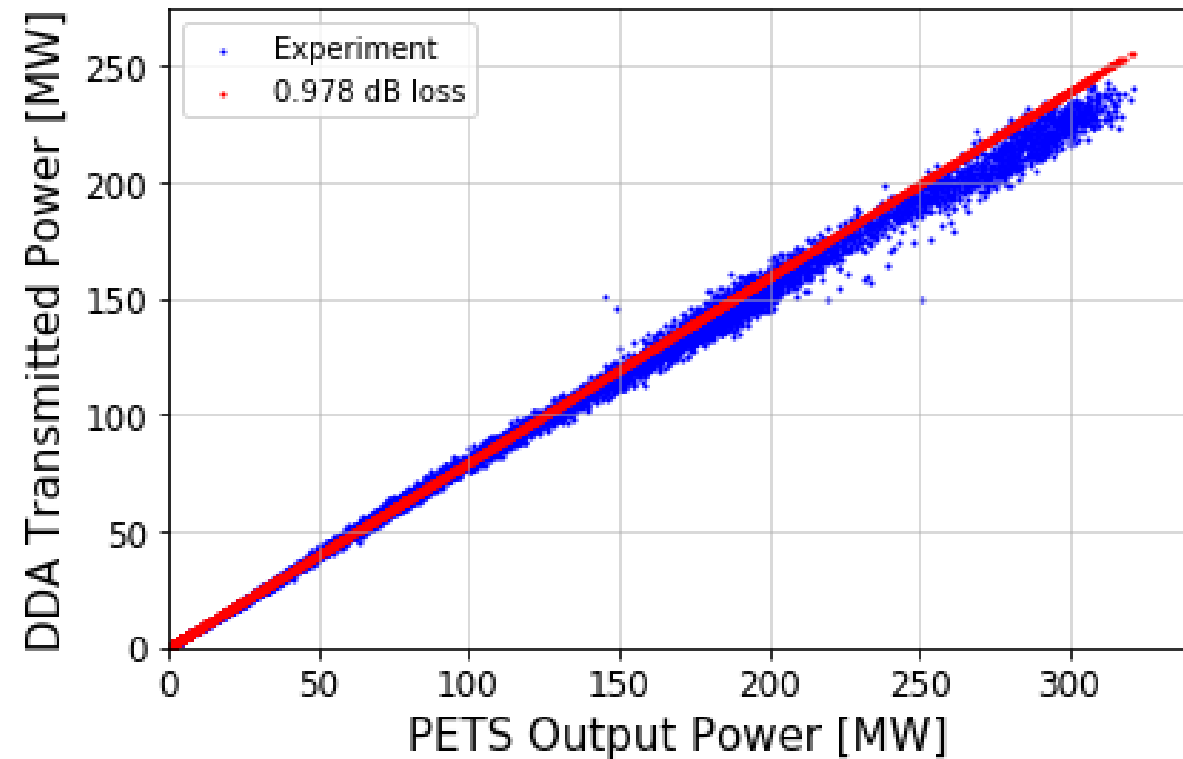
- Measured  $S_{21} = -0.652$  dB &  $S_{11}$  10 dB BW = >640 MHz
- Differences attributable to discrepancies in machined dimensions/dielectric constant
  - Couplers included in simulation
- No tuning required



# Clamped Prototype High Power Test Results

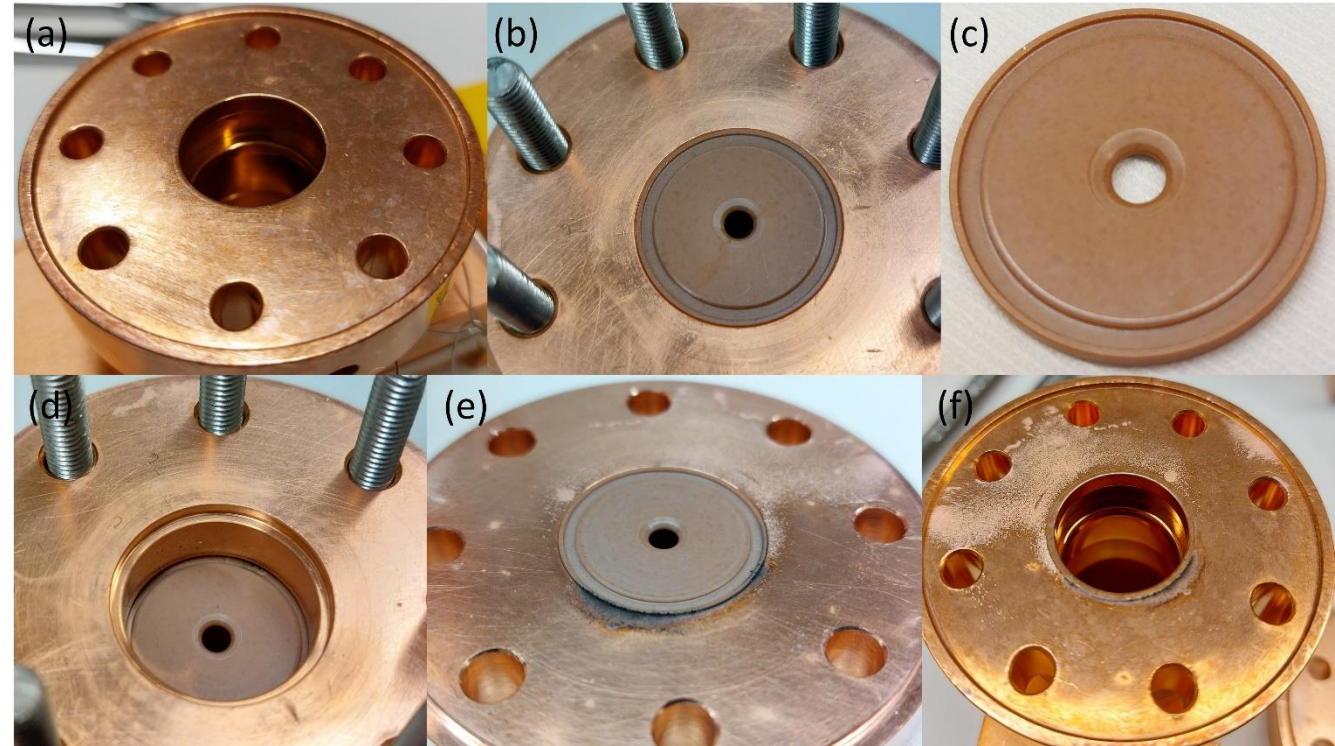
- No evidence (RF or light) of breakdown or multipacting
- Brief period of faint light from interior of structure at highest power conditioned away
- Transmitted power agrees very well with measured transmission loss from DDA+waveguide
- Limited by available input power!

**320.9 MW input power**  
=  
**102.3 MV/m accelerating gradient**



# Clamped Prototype Inspection

- No damage on ceramic or copper in RF volume
- Damage on copper surface and ceramic circumference in one cell due to RF leakage caused by inconsistent clamping force
  - May have been source of brief light during high power test



# Clamped Prototype Conclusions

- No multipactor or RF breakdown observed at high gradient
- Redesigned triple junction solved problem with brazed prototype
- 102.3 MV/m new accelerating gradient record for dielectric disk accelerator!
- Fundamental limit for DDAs still not reached

# Outlook

- Issues yet to be addressed:
  - Are these positive results confined to clamped DDAs?
    - Another brazed DDA in fabrication
  - What engineering challenges arise from “real” accelerating structures?
    - Multicell DDA already designed – S. Weatherly’s poster
  - How to properly stage DDAs to accelerate beam
    - Planned for 2023-2024

# Acknowledgements

- Collaborators

- Scott Doran, Chunguang Jing, Maomoa Peng, John Power, Scott Ross, Jiahang Shao, Linda Spentzouris, Sarah Weatherly, Charles Whiteford, Eric Wisniewski



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